

SCRR1206S1 Series Current Sensing Resistor (Lead / Halogen Free)

Reversion History:

Date	Revision	Changes		
2016/12/12	A0	New Approval Standard		
2018/08/30	A1	0.01~ <1.0Ω		
2018/10/18	A2	0.01~1.0Ω		
2019/9/25	А3	New Approval Standard		
2020/12/21	A4	Tape packaging change		
2021/05/31	A5	Tape packaging dimensions supplementary W value 8.0 ± 0.3 mm		
2023/05/03	A6	Change table paper drawing		

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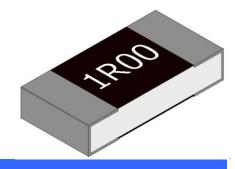
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SCRR1206S1 Series Current Sensing Resistor (Lead / Halogen Free)

Features / Applications :

- High power rating is up to 1W
- RoHS compliant
- Suitable for reflow soldering

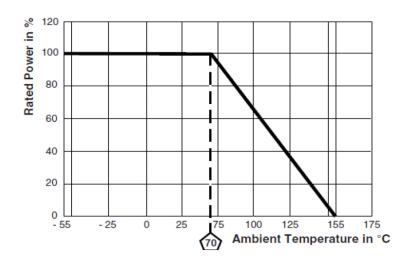


Electrical Specifications:

Characteristics	Feature	
Power Rating*	1 W	
Resistance Range	$0.01\Omega{\sim}1\Omega$	
Temperature Coefficient of Resistance(ppm/°C)	±100	
Resistance Tolerance	±1%(F), ±2%(G), ±5%(J)	
Operation Temperature Range	-55°C ∼ +155°C	

*Note:

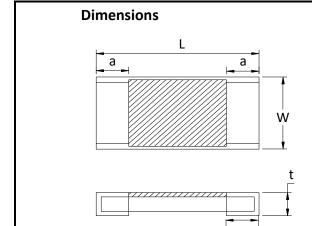
For sensor operated at ambient temperature in excess of 70°C, the maximum load shall be derated in accordance with the following curve.



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Outline Drawing:



L	3.20 ± 0.20		
W	1.60 ± 0.20		
t	0.65 ± 0.20		
а	0.70 ± 0.30		
b	0.70 ± 0.30		

Unit: mm

Type Designation:

1 - 00000 SCRR 1206 S

(1) (2)

(3) (4) - (5) (6)

Note:

- (1) Series No.
- (2) Size
- (3) Terminal type : S = Short terminal
- (4) Power Rating: 1 = 1W
- (5) Resistance value:

The "R" shall be used as a decimal point, For example --

 $R010 = 0.01\Omega$;

(6) Tolerance (%)

F=±1%, G=±2%, J=±5%

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Characteristics:

Electrical

Item	Specification and Requirement	Test Method (JIS 5201)	
Temperature	As electrical specifications	Room temperature	
Coefficient of		Room temperature +100°C	
Resistance(ppm/°C)			
Short Time Overload	△R: ± 0.5%	2.5 x rated power for 5 seconds	
	Without damage by flashover, spark,		
	arcing, burning or breakdown		
Insulation Resistance	Over 100 M Ω on Overcoat layer face up	(1) Setup as figure 1	
	Over 1,000 M Ω on Substrate side face up	(2) Test voltage: 100VDC±15VDC	
		(3) Test time: 60 + 10 / - 0 seconds	
Voltage Proof	Resistance range: ± 1.0%	(1) Setup as figure 1	
	Without damage by flashover, spark,	(2) Test voltage: 400VAC(rms.)	
	arcing, burning or breakdown	(3) Test time: 60 + 10 / - 0 seconds	

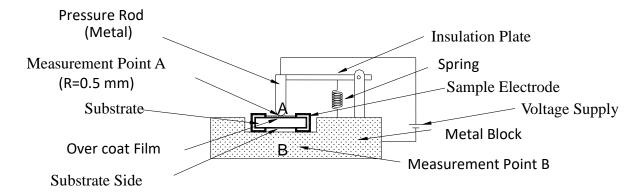


Figure 1 : Measurement Setup

Mechanical

Item	Specification and Requirement	Test Method (JIS 5201)	
Solderability	The surface of terminal immersed shall be	Solder bath:	
	minimum of 95% covered with a new	After immersing in flux, dip in 245 \pm 5 $^{\circ}$ C	
	coating of solder	molten solder bath for 2 ± 0.5 seconds	

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Item	Specification and Requirement		Test Method (JIS 5201)	
Resistance to Solder	△R: ± 1.0%	(1)	(1) Pre-heat: 100~110°C for 30	
Heat	Without distinct deformation in		seconds	
	appearance	(2)	Immersed at solder bath of	
			270 ± 5°C for 10 ± 1 seconds	
Bending Test	△R: ± 1.0%	Ben	Bending value: 3 mm for 30 ± 1 seconds	
	Without mechanical damage such as			
	break			
Solvent Resistance	Without mechanical and distinct damage	(1)	Solvent: Trichloroethane or	
	in appearance		Isopropyl alcohol	
		(2)	Immersed in solvent at room	
			temperature for 300 seconds	

Endurance

Item	Specification and Requirement	Test Method (JIS 5201)	
Rapid Change of	△R: ± 1.0%	-55 ~125℃ 100cycles, 15 min at each	
Temperature	Without distinct damage in appearance	extreme condition	
Moisture with Load	△R: ± 5.0%	$40 \pm 2^{\circ}$ C with relative humidity	
	Without distinct damage in	90% to 95%. D.C. rated voltage for	
	appearance	1.5 hours ON and 0.5 hours OFF.	
		Cycle repeated 1,000 hours	
Load Life	△R: ± 5.0%	Rated voltage for 1.5 hours followed	
	Without distinct damage in	by a pause 0.5 hour at 70 \pm 2 $^{\circ}$ C .	
	appearance	Cycle repeated 1000 hours	
Low Temperature	△R: ± 5.0%	Store temperature:-55 ± 3°C for total	
Store	Without distinct damage in	1,000 hours	
	appearance		
High Temperature	△R: ± 5.0%	Store temperature: 150 ± 2°C for total	
Store	Without distinct damage in	1,000 hours	
	appearance		

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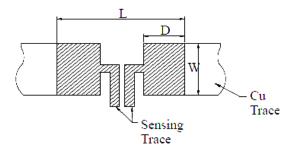
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Recommend Land Pattern Dimensions:

	W	L	D	t
	(mm)	(mm)	(mm)	(μm)
1632	1.78	4.14	1.37	105

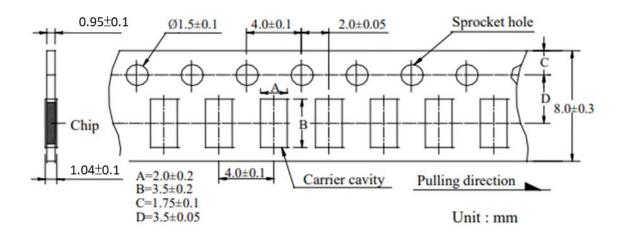
t: Copper foil minimum thickness of PCB



Notice: We recommend there is no circuit design between pads to avoid circuit short.

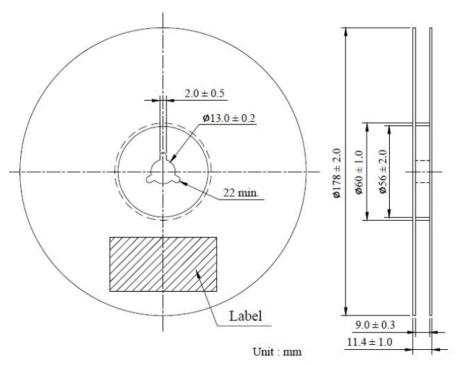
Packaging:

Tape packaging dimensions



Remark: Leader tape length≥30 cm(150 Hollow carrier cavity)

Reel dimensions



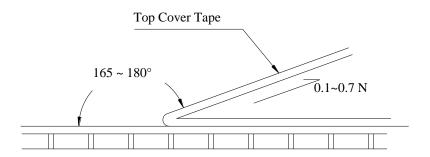
Numbers of Taping: 4,000 pieces /reel

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name

Peel force of top cover tape

The peel speed shall be about 300 mm/min. The peel force of top cover tape shall be between 0.1 to 0.7 N.



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Care Note:

Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen).

Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.

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